

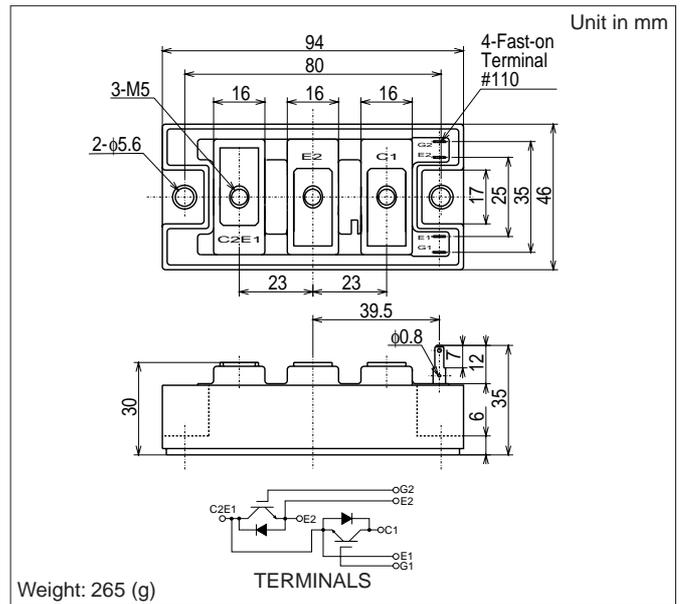
MBM200GS12AW

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High speed and low saturation voltage.
- * low noise due to built-in free-wheeling diode - ultra soft fast recovery diode(USFD).
- * Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (T_c=25°C)

Item	Symbol	Unit	MBM200GS12AW
Collector Emitter Voltage	V _{CES}	V	1,200
Gate Emitter Voltage	V _{GES}	V	±20
Collector Current	DC	I _c	200
	1ms	I _{cp}	400
Forward Current	DC	I _F	200 (1)
	1ms	I _{FM}	400
Collector Power Dissipation	P _c	W	1,000
Junction Temperature	T _j	°C	-40 ~ +150
Storage Temperature	T _{stg}	°C	-40 ~ +125
Isolation Voltage	V _{ISO}	V _{RMS}	2,500(AC 1 minute)
Screw Torque	Terminals	-	1.96(20) (2)
	Mounting	-	1.96(20) (3)

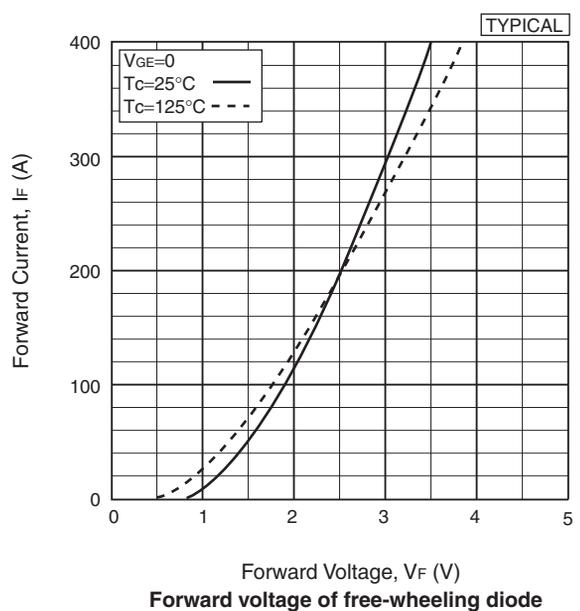
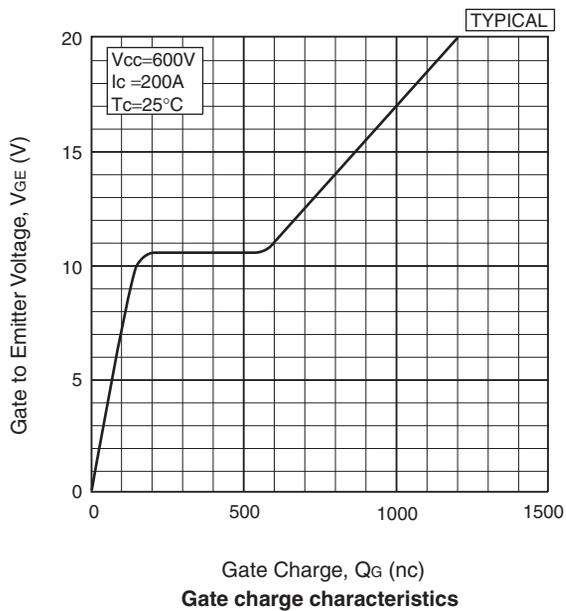
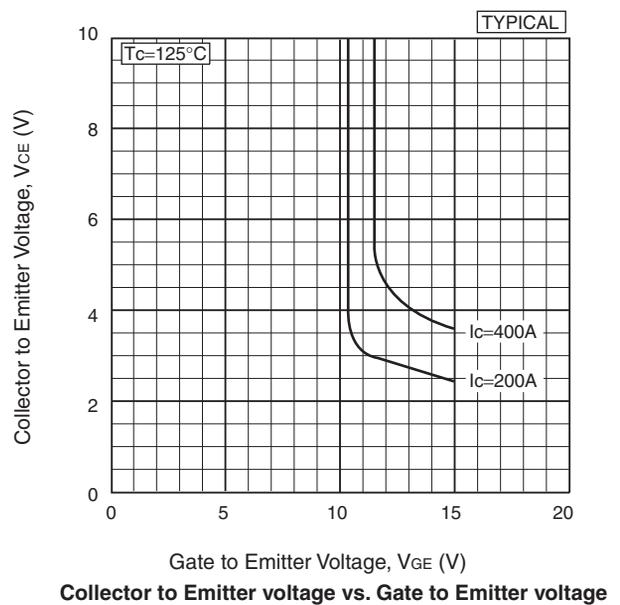
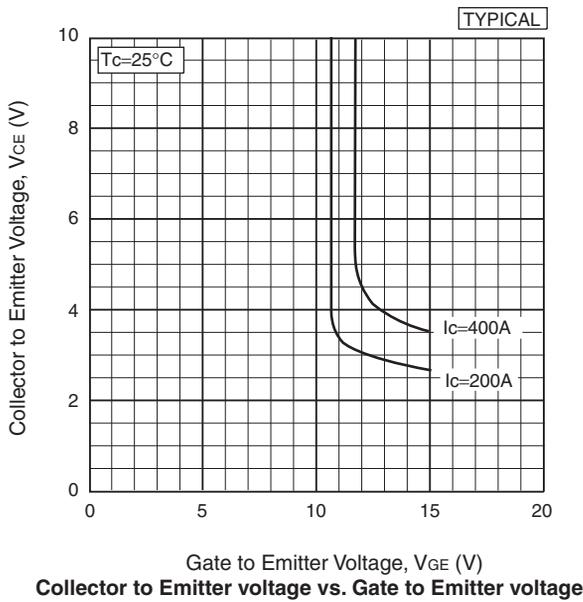
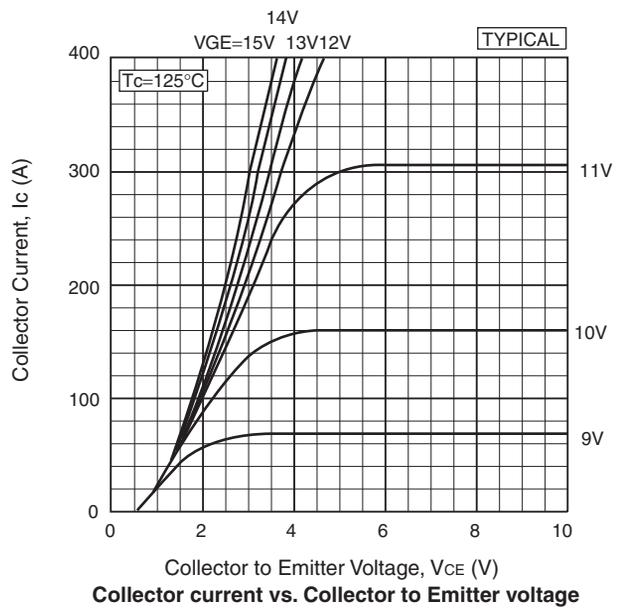
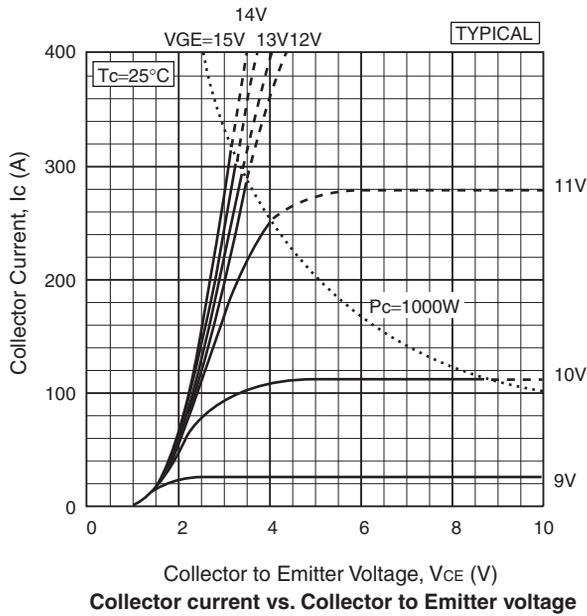
Notes:(1)RMS Current of Diode 60Arms max.

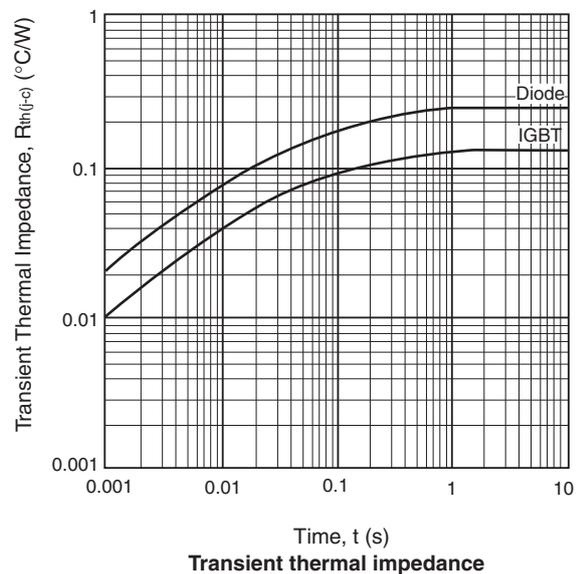
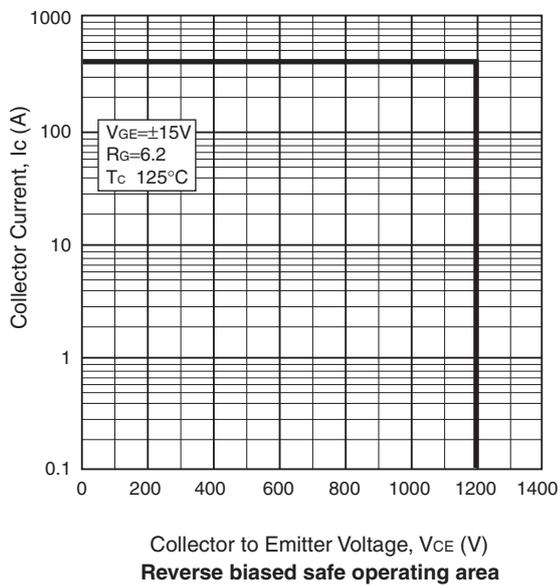
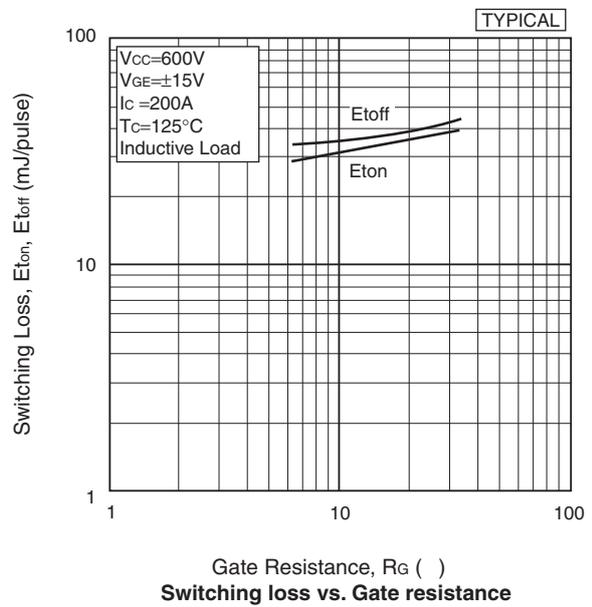
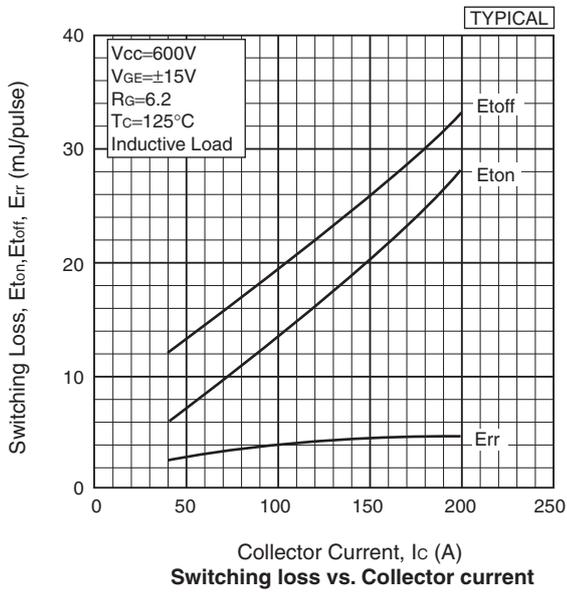
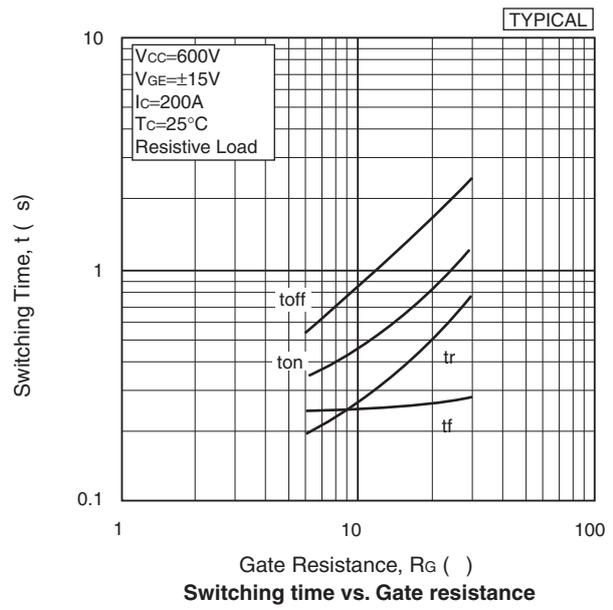
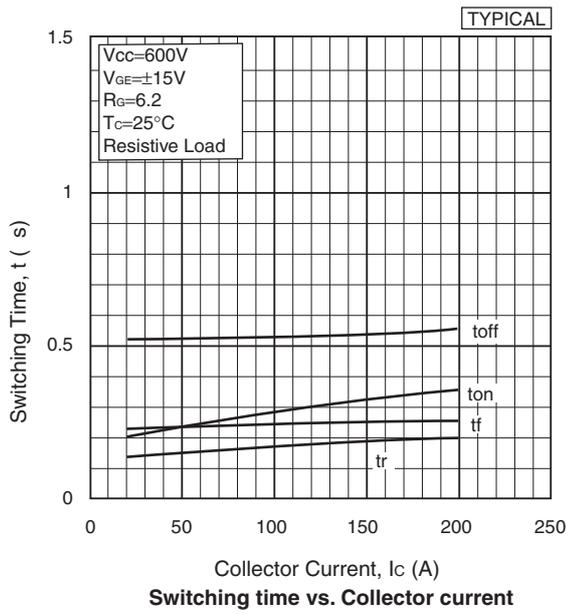
(2)(3)Recommended Value 1.67N.m(17kgf.cm)

CHARACTERISTICS (T_c=25°C)

Item	Symbol	Unit	Min.	Typ.	Max.	Test Conditions	
Collector Emitter Cut-Off Current	I _{CES}	mA	-	-	1.0	V _{CE} =1,200V, V _{GE} =0V	
Gate Emitter Leakage Current	I _{GES}	nA	-	-	±500	V _{GE} =±20V, V _{CE} =0V	
Collector Emitter Saturation Voltage	V _{CE(sat)}	V	-	2.7	3.4	I _c =200A, V _{GE} =15V	
Gate Emitter Threshold Voltage	V _{GE(TO)}	V	-	-	10	V _{CE} =5V, I _c =200mA	
Input Capacitance	C _{ies}	pF	-	19,000	-	V _{CE} =10V, V _{GE} =0V, f=1MHz	
Switching Times	Rise Time	t _r	-	0.2	0.35	V _{CC} =600V	
	Turn On Time	t _{on}	-	0.35	0.55	R _L =3.0Ω	
	Fall Time	t _f	-	0.25	0.35	R _G =6.2Ω (4)	
	Turn Off Time	t _{off}	-	0.55	1.0	V _{GE} =±15V	
Peak Forward Voltage Drop	V _{FM}	V	-	2.5	3.5	I _F =200A, V _{GE} =0V	
Reverse Recovery Time	t _{rr}	μs	-	-	0.35	I _F =200A, V _{GE} =-10V, di/dt=300A/μs	
Thermal Impedance	IGBT	R _{th(j-c)}	°C/W	-	-	0.125	Junction to case
	FWD	R _{th(j-c)}	°C/W	-	-	0.25	

Notes:(4) R_G value is the test condition's value for decision of the switching times, not recommended value.Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted.





HITACHI POWER SEMICONDUCTORS

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